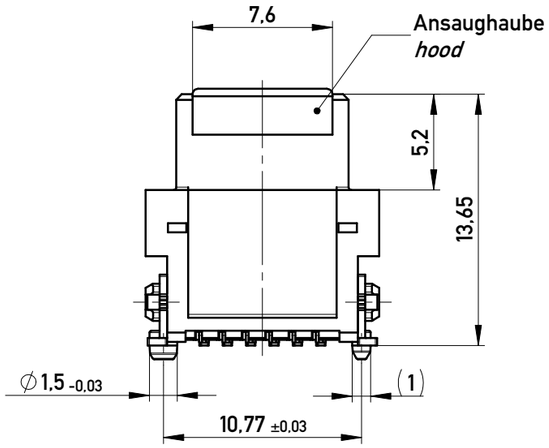
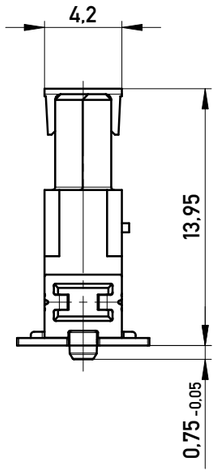
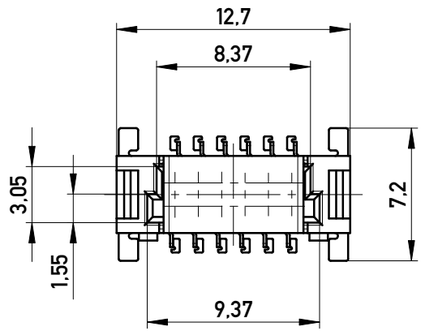
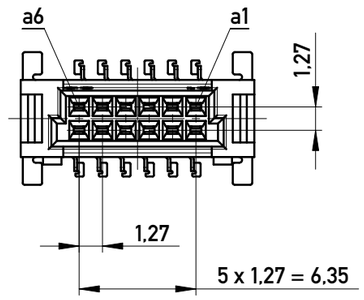
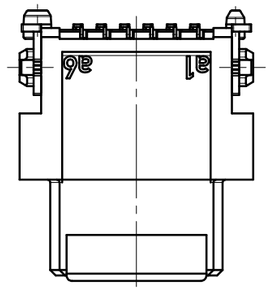




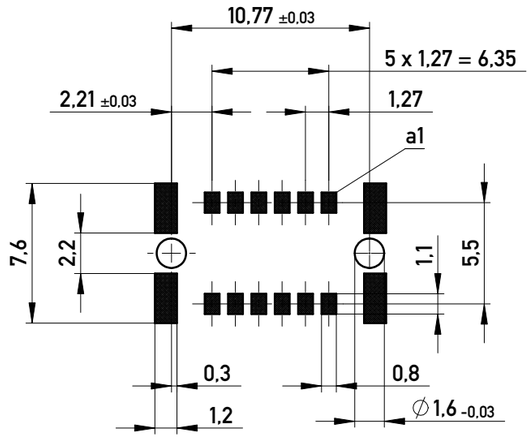


ohne Ansaughaube - *without hood*





Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



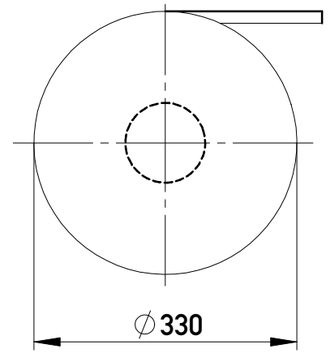
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

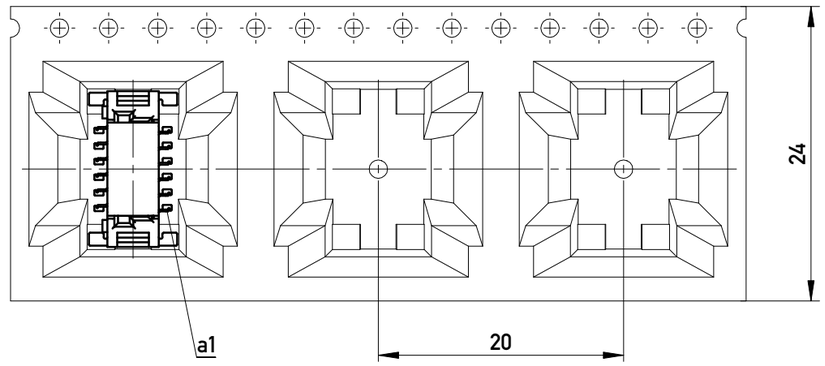
Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 170 Stück
Packaging unit: 170 pcs



Abspulrichtung - *Reel off Direction*



BA 7-23 - hohe Bauhöhe
type 7-23 - high profile

Information:

Tolerances

All Dimensions in mm

Scale 3:1

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Subject to modification without prior notice.
Drawing will not be updated.

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Designation
Federl. SMC-B 12-SMD-BA7-23
Female SMC-B 12-SMT-type7-23

100103210050

Index		Date	
b		06.06.2014	

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A3

Class SMCB